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32-bit dual supply translating transceiver with configurable voltage translation; 3-state

Rev. 1 — 16 January 2013

Product data sheet

1. General description

The 74AVC32T245 is a 32-bit transceiver with bidirectional level voltage translation and 3-state outputs. The device can be used as eight 8-bit input-output ports (nAn and nBn), two 16-bit transceiver or as a 32-bit transceiver. It has dual supplies ($V_{CC(A)}$ and $V_{CC(B)}$) for voltage translation and four 8-bit input-output ports (nAn and nBn) each with its own output enable (nOE) and send/receive (nDIR) input for direction control. $V_{CC(A)}$ and $V_{CC(B)}$ can be independently supplied at any voltage between 0.8 V and 3.6 V making the device suitable for low voltage translation between any of the following voltages: 0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V. A HIGH on nDIR selects transmission from nAn to nBn while a LOW on nDIR selects transmission from nBn to nAn. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state

The device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either V_{CC(A)} or V_{CC(B)} are at GND level, both nAn and nBn are in the high-impedance OFF-state.

2. Features and benefits

- Wide supply voltage range:
 - V_{CC(A)}: 0.8 V to 3.6 V
 - V_{CC(B)}: 0.8 V to 3.6 V
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - JESD8-11 (0.9 V to 1.65 V)
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F Class 3B exceeds 8000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101D exceeds 1000 V
- Maximum data rates:
 - ◆ 380 Mbit/s (≥ 1.8 V to 3.3 V translation)
 - ◆ 200 Mbit/s (≥ 1.1 V to 3.3 V translation)
 - ◆ 200 Mbit/s (≥ 1.1 V to 2.5 V translation)
 - 200 Mbit/s (\geq 1.1 V to 1.8 V translation)
 - ◆ 150 Mbit/s (≥ 1.1 V to 1.5 V translation)



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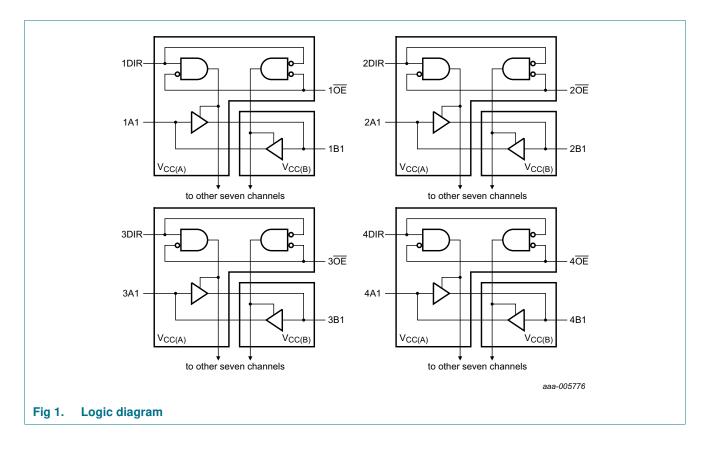
- ◆ 100 Mbit/s (≥ 1.1 V to 1.2 V translation)
- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information	n
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Type number	Package							
	Temperature range	Name	Description	Version				
74AVC32T245EC	–40 °C to +125 °C	LFBGA96	plastic low profile fine-pitch ball grid array package; 96 balls; body $13.5 \times 5.5 \times 1.05$ mm	SOT536-1				

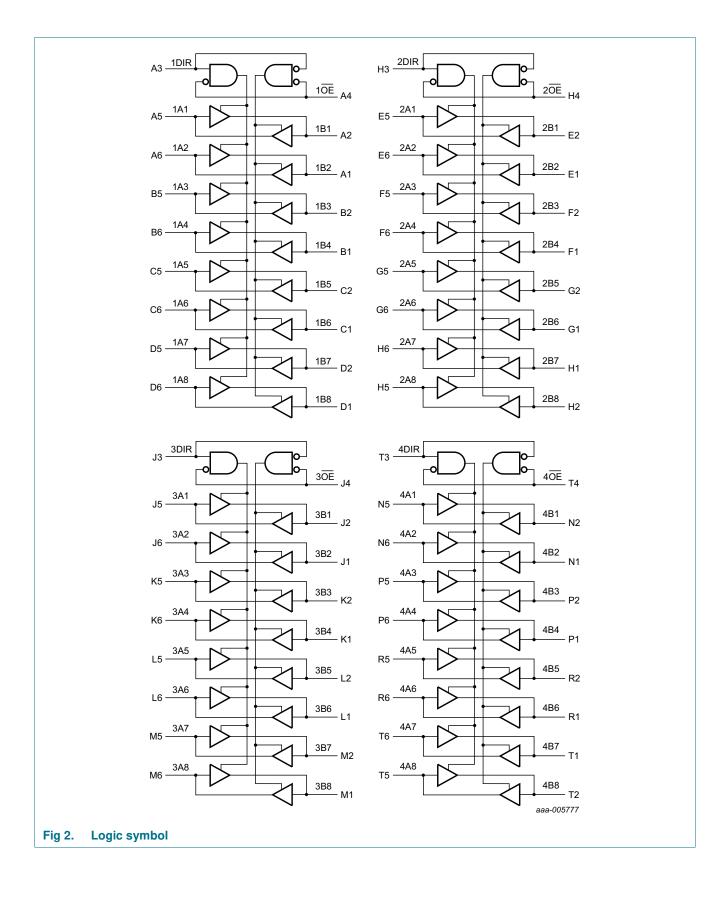
4. Functional diagram



74AVC32T245 Product data sheet

74AVC32T245

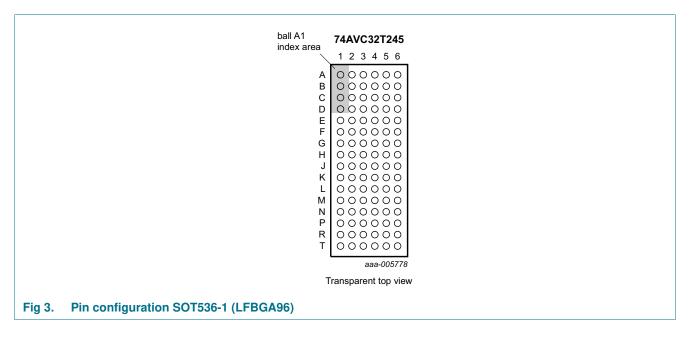
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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.Pin description

Symbol	Ball	Description
1DIR, 2DIR, 3DIR, 4DIR	A3, H3, J3, T3	direction control
$1\overline{OE}$, $2\overline{OE}$, $3\overline{OE}$, $4\overline{OE}$	A4, H4, J4, T4	output enable input (active LOW)
1A1 to 1A8	A5, A6, B5, B6, C5, C6, D5, D6	input or output
1B1 to 1B8	A2, A1, B2, B1, C2, C1, D2, D1	input or output
2A1 to 2A8	E5, E6, F5, F6, G5, G6, H6, H5	input or output
2B1 to 2B8	E2, E1, F2, F1, G2, G1, H1, H2	input or output
3A1 to 3A8	J5, J6, K5, K6, L5, L6, M5, M6	input or output
3B1 to 3B8	J2, J1, K2, K1, L2, L1, M2, M1	input or output
4A1 to 4A8	N5, N6, P5, P6, R5, R6, T6, T5	input or output
4B1 to 4B8	N2, N1, P2, P1, R2, R1, T1, T2	input or output
GND ^[1]	B3, B4, D3, D4, E3, E4, G3, G4, K3, K4, M3, M4, N3, N4, R3, R4	ground (0 V)
V _{CC(A)}	C4, F4, L4, P4	supply voltage A (nAn, $n\overline{\text{OE}}$ and nDIR inputs are referenced to $V_{\text{CC}(A)})$
V _{CC(B)}	C3, F3, L3, P3	supply voltage B (nBn inputs are referenced to $V_{CC(B)})$

[1] All GND pins must be connected to ground (0 V).

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6. Functional description

Table 3. Function table ^[1]							
Supply voltage	Input		Input/output ^[3]	Input/output ^[3]			
V _{CC(A)} , V _{CC(B)}	nOE ^[2]	nDIR ^[2]	nAn ^[2]	nBn ^[2]			
0.8 V to 3.6 V	L	L	nAn = nBn	input			
0.8 V to 3.6 V	L	Н	input	nBn = nAn			
0.8 V to 3.6 V	Н	Х	Z	Z			
GND[3]	Х	Х	Z	Z			

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The nAn, nDIR and n \overline{OE} input circuit is referenced to V_{CC(A)}; The nBn input circuit is referenced to V_{CC(B)}.

[3] If at least one of $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+4.6	V
V _{CC(B)}	supply voltage B		-0.5	+4.6	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> –0.5	$V_{CCO} + 0.5$	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CCO}	[2] -	±50	mA
I _{CC}	supply current	per $V_{CC(A)}$ or $V_{CC(B)}$ pin	-	100	mA
I _{GND}	ground current	per GND pin	-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$			
		LFBGA96 package	<u>[4]</u> _	1000	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] V_{CCO} + 0.5 V should not exceed 4.6 V.

[4] Above 70 °C the value of P_{tot} derates linearly with 1.8 mW/K.

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8. Recommended operating conditions

Recommended operating conditions							
Parameter	Conditions	Min	Max	Unit			
supply voltage A		0.8	3.6	V			
supply voltage B		0.8	3.6	V			
input voltage		0	3.6	V			
output voltage	Active mode	<u>[1]</u> 0	V _{CCO}	V			
	Suspend or 3-state mode	0	3.6	V			
ambient temperature		-40	+125	°C			
input transition rise and fall rate	$V_{CCI} = 0.8 \text{ V}$ to 3.6 V	[2] _	5	ns/V			
	Parameter supply voltage A supply voltage B input voltage output voltage ambient temperature	Parameter Conditions supply voltage A	Parameter Conditions Min supply voltage A 0.8 supply voltage B 0.8 input voltage 0 output voltage 0 ambient temperature -40	ParameterConditionsMinMaxsupply voltage A0.83.6supply voltage B0.83.6input voltage03.6output voltage03.6output voltageActive mode110V _{CCO} Suspend or 3-state mode03.6ambient temperature-40+125			

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the input port.

9. Static characteristics

Table 6. Typical static characteristics at $T_{amb} = 25 \text{ °C} \frac{[1][2]}{2}$

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.69	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = 1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.07	-	V
lı	input leakage current	nDIR, n \overline{OE} input; V _I = 0 V or 3.6 V; V _{CC(A)} = V _{CC(B)} = 0.8 V to 3.6 V	-	±0.025	±0.25	μA
I _{OZ}	OFF-state output current	A or B port; $V_O = 0$ V or V_{CCO} ; $V_{CC(A)} = V_{CC(B)} = 3.6$ V	<u>[3]</u> _	±0.5	±2.5	μA
		suspend mode A port; V _O = 0 V or V _{CCO} ; V _{CC(A)} = 3.6 V; V _{CC(B)} = 0 V	<u>[3]</u> _	±0.5	±2.5	μA
		suspend mode B port; V_O = 0 V or V_{CCO}; V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V	[3] _	±0.5	±2.5	μA
I _{OFF}	power-off leakage current	A port; V _I or V _O = 0 V to 3.6 V; V _{CC(A)} = 0 V; V _{CC(B)} = 0.8 V to 3.6 V	-	±0.1	±1	μA
		B port; V _I or V _O = 0 V to 3.6 V; V _{CC(B)} = 0 V; V _{CC(A)} = 0.8 V to 3.6 V	-	±0.1	±1	μA
Cı	input capacitance	nDIR, n \overline{OE} input; V _I = 0 V or 3.3 V; V _{CC(A)} = V _{CC(B)} = 3.3 V	-	2.0	-	рF
C _{I/O}	input/output capacitance	A and B port; $V_O = 3.3$ V or 0 V; $V_{CC(A)} = V_{CC(B)} = 3.3$ V	-	4.5	-	pF

[1] V_{CCO} is the supply voltage associated with the output port.

 $\label{eq:VCCI} \ensuremath{\left[2\right]} \quad V_{CCI} \ensuremath{\text{ is the supply voltage associated with the data input port.}$

[3] For I/O ports, the parameter I_{OZ} includes the input leakage current.

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-40 °C to +85 °C Symbol Parameter Conditions -40 °C to +125 °C Unit Min Min Max Max VIH HIGH-level data input input voltage $V_{CCI} = 0.8 V$ 0.70V_{CCI} 0.70V_{CCI} V _ -V_{CCI} = 1.1 V to 1.95 V 0.65V_{CCL} 0.65V_{CCI} ٧ -- $V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$ 1.6 1.6 ٧ -- $V_{CCI} = 3.0 \text{ V}$ to 3.6 V 2 _ 2 ٧ _ nDIR, nOE input $V_{CC(A)} = 0.8 V$ 0.70V_{CC(A)} 0.70V_{CC(A)} V --0.65V_{CC(A)} V V_{CC(A)} = 1.1 V to 1.95 V 0.65V_{CC(A)} -- $V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$ 1.6 1.6 V _ - $V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$ 2 2 V _ -VIL LOW-level data input input voltage $V_{CCI} = 0.8 V$ 0.30V_{CCI} 0.30V_{CCI} V _ -V_{CCI} = 1.1 V to 1.95 V 0.35V_{CCI} 0.35V_{CCI} V -- $V_{CCI} = 2.3 \text{ V}$ to 2.7 V 0.7 0.7 ٧ _ - $V_{CCI} = 3.0 \text{ V}$ to 3.6 V 0.8 0.8 ٧ _ nDIR, nOE input $V_{CC(A)} = 0.8 V$ 0.30V_{CC(A)} 0.30V_{CC(A)} V _ -V_{CC(A)} = 1.1 V to 1.95 V 0.35V_{CC(A)} 0.35V_{CC(A)} V _ - $V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$ 0.7 0.7 ٧ -- $V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$ 0.8 -0.8 V _ V_{OH} HIGH-level $V_{I} = V_{IH} \text{ or } V_{II}$ output voltage $I_{O} = -100 \ \mu A;$ $V_{CCO} - 0.1$ $V_{CCO}-0.1$ ٧ -_ $V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V to } 3.6 \text{ V}$ $I_{O} = -3 \text{ mA};$ 0.85 0.85 ٧ -- $V_{CC(A)} = V_{CC(B)} = 1.1 V$ $I_{O} = -6 \text{ mA};$ 1.05 1.05 ٧ -- $V_{CC(A)} = V_{CC(B)} = 1.4 V$ $I_{O} = -8 \text{ mA};$ 1.2 _ 1.2 -٧ $V_{CC(A)} = V_{CC(B)} = 1.65 V$ $I_{O} = -9 \text{ mA};$ 1.75 1.75 V _ _ $V_{CC(A)} = V_{CC(B)} = 2.3 V$ $I_{O} = -12 \text{ mA};$ 2.3 ٧ 2.3 - $V_{CC(A)} = V_{CC(B)} = 3.0 V$

Table 7. Static characteristics [1][2]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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Symbol	Parameter	Conditions		–40 °C t	to +85 °C	–40 °C to	o +125 °C	Unit
				Min	Max	Min	Max	
V _{OL}	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$						
	output voltage			-	0.1	-	0.1	V
		$I_{O} = 3 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$		-	0.25	-	0.25	V
		$I_{O} = 6 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$		-	0.35	-	0.35	V
		$I_{O} = 8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$		-	0.45	-	0.45	V
		$I_{O} = 9 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$		-	0.55	-	0.55	V
		$\label{eq:loss} \begin{array}{l} I_{O} = 12 \text{ mA}; \\ V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V} \end{array}$		-	0.7	-	0.7	V
I	input leakage current	nDIR, n $\overline{\text{OE}}$ input; V _I = 0 V or 3.6 V; V _{CC(A)} = V _{CC(B)} = 0.8 V to 3.6 V		-	±1	-	±5	μA
I _{OZ}	OFF-state output current	A or B port; $V_O = 0$ V or V_{CCO} ; $V_{CC(A)} = V_{CC(B)} = 3.6$ V	<u>[3]</u>	-	±5	-	±30	μA
		suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 3.6 V;$ $V_{CC(B)} = 0 V$	<u>[3]</u>	-	±5	-	±30	μA
		suspend mode B port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 0 V;$ $V_{CC(B)} = 3.6 V$	<u>[3]</u>	-	±5	-	±30	μA
I _{OFF}	power-off leakage	$ \begin{array}{l} A \mbox{ port; } V_{1} \mbox{ or } V_{O} = 0 \mbox{ V to } 3.6 \mbox{ V;} \\ V_{CC(A)} = 0 \mbox{ V; } V_{CC(B)} = 0.8 \mbox{ V to } 3.6 \mbox{ V} \end{array} $		-	±5	-	±30	μA
	current	$ \begin{array}{l} B \mbox{ port; } V_{1} \mbox{ or } V_{O} = 0 \mbox{ V to } 3.6 \mbox{ V;} \\ V_{CC(B)} = 0 \mbox{ V; } V_{CC(A)} = 0.8 \mbox{ V to } 3.6 \mbox{ V} \end{array} $		-	±5	-	±30	μA

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Max	Min	Max	
I _{CC}	supply current	A port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A					
		$V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	60	-	250	μA
		$V_{CC(A)} = 1.1 V \text{ to } 3.6 V;$ $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$	-	50	-	200	μA
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-	50	-	200	μA
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-10	-	-40	-	μA
		B port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A					
		$V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	60	-	250	μA
		$V_{CC(A)} = 1.1 V \text{ to } 3.6 V;$ $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$	-	50	-	200	μA
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-10	-	-40	-	μA
		$V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$	-	50	-	200	μA
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0$ A; $V_I = 0$ V or V_{CCI} ; $V_{CC(A)} = 0.8$ V to 3.6 V; $V_{CC(B)} = 0.8$ V to 3.6 V	-	110	-	370	μΑ
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0 A$; $V_I = 0 V \text{ or } V_{CCI}$; $V_{CC(A)} = 1.1 V \text{ to } 3.6 V$; $V_{CC(B)} = 1.1 V \text{ to } 3.6 V$	-	90	-	300	μΑ

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the data input port.

[3] For I/O ports, the parameter I_{OZ} includes the input leakage current.

Table 8. Typical total supply current (I_{CC(A)} + I_{CC(B)})

V _{CC(A)}	V _{CC(B)}							Unit
	0 V	0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
0 V	0	0.2	0.2	0.2	0.2	0.2	0.2	μA
0.8 V	0.2	0.2	0.2	0.2	0.2	0.6	3.2	μA
1.2 V	0.2	0.2	0.2	0.2	0.2	0.2	1.6	μA
1.5 V	0.2	0.2	0.2	0.2	0.2	0.2	0.8	μA
1.8 V	0.2	0.2	0.2	0.2	0.2	0.2	0.4	μA
2.5 V	0.2	0.6	0.2	0.2	0.2	0.2	0.2	μA
3.3 V	0.2	3.2	1.6	0.8	0.4	0.2	0.2	μA

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10. Dynamic characteristics

Table 9. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C } [1][2]$

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions			V _{CC(A)} =	= V _{CC(B)}			Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
	power dissipation capacitance	A port: (direction nAn to nBn); output enabled	0.2	0.2	0.2	0.2	0.3	0.4	pF
		A port: (direction nAn to nBn); output disabled	0.2	0.2	0.2	0.2	0.3	0.4	pF
		A port: (direction nBn to nAn); output enabled	9	9.7	9.8	10.3	11.7	13.7	pF
		A port: (direction nBn to nAn); output disabled	0.6	0.6	0.6	0.7	0.7	0.7	pF
		B port: (direction nAn to nBn); output enabled	9	9.7	9.8	10.3	11.7	13.7	pF
		B port: (direction nAn to nBn); output disabled	0.6	0.6	0.6	0.7	0.7	0.7	рF
		B port: (direction nBn to nAn); output enabled	0.2	0.2	0.2	0.2	0.3	0.4	pF
		B port: (direction nBn to nAn); output disabled	0.2	0.2	0.2	0.2	0.3	0.4	pF

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

[2] $f_i = 10 \text{ MHz}$; $V_I = \text{GND}$ to V_{CC} ; $t_r = t_f = 1 \text{ ns}$; $C_L = 0 \text{ pF}$; $R_L = \infty \Omega$.

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Symbol	Devementar	Conditions			V				Unit
Symbol	Parameter	Conditions	V _{CC(B)}						
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t _{pd}	propagation delay	nAn to nBn	14.4	7.0	6.2	6.0	5.9	6.0	ns
	nBn to nAn	14.4	12.4	12.1	11.9	11.8	11.8	ns	
t _{dis}	disable time	nOE to nAn	16.2	16.2	16.2	16.2	16.2	16.2	ns
		nOE to nBn	17.6	10.0	9.0	9.1	8.7	9.3	ns
t _{en} enab	enable time	nOE to nAn	21.9	21.9	21.9	21.9	21.9	21.9	ns
		nOE to nBn	22.2	11.1	9.8	9.4	9.4	9.6	ns

Table 10. Typical dynamic characteristics at $V_{CC(A)} = 0.8 V$ and $T_{amb} = 25 \ ^{\circ}C$ [1]Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Figure 5

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

Table 11. Typical dynamic characteristics at $V_{CC(B)} = 0.8$ V and $T_{amb} = 25$ °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Figure 5

Symbol	Parameter	Conditions			Vco	C(A)			Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t _{pd}	t _{pd} propagation delay	nAn to nBn	14.4	12.4	12.1	11.9	11.8	11.8	ns
		nBn to nAn	14.4	7.0	6.2	6.0	5.9	6.0	ns
t _{dis}	t _{dis} disable time	nOE to nAn	16.2	5.9	4.4	4.2	3.1	3.5	ns
		nOE to nBn	17.6	14.2	13.7	13.6	13.3	13.1	ns
t _{en}	t _{en} enable time	nOE to nAn	21.9	6.4	4.4	3.5	2.6	2.3	ns
		nOE to nBn	22.2	17.7	17.2	17.0	16.8	16.7	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}; t_{en} is the same as t_{PZL} and t_{PZH}.

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Symbol	Parameter	Conditions					٧c	C(B)					Uni
			1.2 V ± 0.1 V		1.5 V :	± 0.1 V	1	0.15 V	2.5 V	± 0.2 V	3.3 V :	± 0.3 V	
			Min	Мах	Min	Max	Min	Мах	Min	Max	Min	Max	_
V _{CC(A)} =	1.1 V to 1.3 V			•									•
t _{pd}	propagation	nAn to nBn	0.5	9.2	0.5	6.9	0.5	6.0	0.5	5.1	0.5	4.9	ns
	delay	nBn to nAn	0.5	9.2	0.5	8.7	0.5	8.5	0.5	8.2	0.5	8.0	ns
t _{dis}	disable time	nOE to nAn	1.5	11.6	1.5	11.6	1.5	11.6	1.5	11.6	1.5	11.6	ns
		nOE to nBn	1.5	12.5	1.5	9.7	1.5	9.5	1.0	8.1	1.0	8.9	ns
t _{en}	enable time	nOE to nAn	1.0	14.5	1.0	14.5	1.0	14.5	1.0	14.5	1.0	14.5	ns
		nOE to nBn	1.1	14.9	1.1	11.0	1.1	9.6	1.0	8.1	1.0	7.7	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
t _{pd}	propagation	nAn to nBn	0.5	8.7	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	ns
	delay	nBn to nAn	0.5	6.9	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	ns
t _{dis}	disable time	nOE to nAn	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	ns
		nOE to nBn	1.5	11.4	1.5	8.7	1.5	7.5	1.0	6.5	1.0	6.3	ns
t _{en} enable tim	enable time	nOE to nAn	1.0	10.1	1.0	10.1	1.0	10.1	1.0	10.1	1.0	10.1	ns
		nOE to nBn	1.0	13.5	1.0	10.1	0.5	8.1	0.5	5.9	0.5	5.2	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
t _{pd} propagatio delay	propagation	nAn to nBn	0.5	8.5	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3	ns
		nBn to nAn	0.5	6.0	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	ns
t _{dis}	disable time	nOE to nAn	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	ns
		nOE to nBn	1.5	11.1	1.5	8.4	1.5	7.1	1.0	5.9	1.0	5.7	ns
t _{en}	enable time	nOE to nAn	1.0	7.8	1.0	7.8	1.0	7.8	1.0	7.8	1.0	7.8	ns
0.1		nOE to nBn	1.0	13.0	1.0	9.2	0.5	7.4	0.5	5.3	0.5	4.5	ns
$V_{CC(A)} = $	2.3 V to 2.7 V												
	propagation	nAn to nBn	0.5	8.2	0.5	5.6	0.5	4.6	0.5	3.3	0.5	2.8	ns
20	delay	nBn to nAn	0.5	5.1	0.5	4.1	0.5	3.7	0.5	3.4	0.5	3.2	ns
t _{dis}	disable time	nOE to nAn	1.0	6.1	1.0	6.1	1.0	6.1	1.0	6.1	1.0	6.1	ns
2.0		nOE to nBn	1.0	10.6	1.0	7.9	1.0	6.6	1.0	6.1	1.0	5.2	ns
t _{en}	enable time	nOE to nAn	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	ns
		nOE to nBn	0.5	12.5	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
t _{pd}	propagation	nAn to nBn	0.5	8.0	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7	ns
μu	delay	nBn to nAn	0.5	4.9	0.5	3.7	0.5	3.3	0.5	2.9	0.5	2.7	ns
t _{dis}	disable time	nOE to nAn	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	ns
-013		nOE to nBn	1.0	10.3	1.0	7.7	1.0	6.5	1.0	5.2	0.5	5.0	ns
t _{en}	enable time	nOE to nAn	0.5	4.3	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4.0	ns
•ell		nOE to nAn	0.5	12.4	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4.0	ns

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C [1]Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Fig.

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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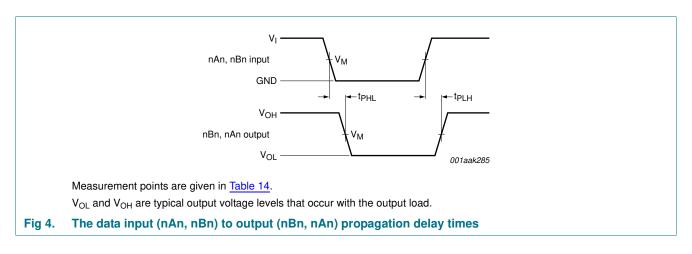
Symbol	Parameter	Conditions	V _{CC(B)}									Uni	
			$1.2 V \pm 0.1 V$		1.5 V :	± 0.1 V	1	0.15 V	$2.5 \text{ V} \pm 0.2 \text{ V}$		3.3 V :	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	1
$V_{CC(A)} =$	1.1 V to 1.3 V												
t _{pd}	propagation	nAn to nBn	0.5	10.2	0.5	7.6	0.5	6.6	0.5	5.7	0.5	5.4	ns
	delay	nBn to nAn	0.5	10.2	0.5	9.6	0.5	9.4	0.5	9.1	0.5	8.8	ns
t _{dis}	disable time	n <mark>OE</mark> to nAn	1.5	12.8	1.5	12.8	1.5	12.8	1.5	12.8	1.5	12.8	ns
		nOE to nBn	1.5	13.8	1.5	10.7	1.5	10.5	1.0	9.0	1.5	9.8	ns
t _{en}	enable time	n OE to nAn	1.0	16.0	1.0	16.0	1.0	16.0	1.0	16.0	1.0	16.0	ns
		nOE to nBn	1.1	16.4	1.1	12.1	1.1	10.6	1.0	9.0	1.0	8.5	ns
$V_{CC(A)} =$	1.4 V to 1.6 V												
t _{pd}	propagation	nAn to nBn	0.5	9.6	0.5	6.9	0.5	5.8	0.5	4.6	0.5	4.1	ns
	delay	nBn to nAn	0.5	7.6	0.5	6.9	0.5	6.5	0.5	6.2	0.5	6.1	ns
t _{dis}	disable time	n <mark>OE</mark> to nAn	1.5	10.1	1.5	10.1	1.5	10.1	1.5	10.1	1.5	10.1	ns
		nOE to nBn	1.5	12.6	1.5	9.6	1.5	8.3	1.0	7.2	1.0	7.0	ns
t _{en} enal	enable time	n <mark>OE</mark> to nAn	1.0	11.2	1.0	11.2	1.0	11.2	1.0	11.2	1.0	11.2	ns
		nOE to nBn	1.0	14.9	1.0	11.2	0.5	9.0	0.5	6.5	0.5	5.8	ns
$V_{CC(A)} =$	1.65 V to 1.95	V											
t _{pd} propagation delay	nAn to nBn	0.5	9.4	0.5	6.5	0.5	5.3	0.5	4.1	0.5	3.7	ns	
	delay	nBn to nAn	0.5	6.6	0.5	5.8	0.5	5.3	0.5	5.0	0.5	4.9	ns
t _{dis}	disable time	n <mark>OE</mark> to nAn	1.5	8.5	1.5	8.5	1.5	8.5	1.5	8.5	1.5	8.5	ns
		nOE to nBn	1.5	12.3	1.5	9.3	1.5	7.9	1.0	6.5	1.0	6.3	ns
t _{en} e	enable time	nOE to nAn	1.0	8.6	1.0	8.6	1.0	8.6	1.0	8.6	1.0	8.6	ns
		nOE to nBn	1.0	14.3	1.0	10.2	0.5	8.2	0.5	5.9	0.5	5.0	ns
$V_{CC(A)} =$	2.3 V to 2.7 V												
t _{pd}	propagation	nAn to nBn	0.5	9.1	0.5	6.2	0.5	5.1	0.5	3.7	0.5	3.1	ns
	delay	nBn to nAn	0.5	5.7	0.5	4.6	0.5	4.1	0.5	3.8	0.5	3.6	ns
t _{dis}	disable time	nOE to nAn	1.0	6.8	1.0	6.8	1.0	6.8	1.0	6.8	1.0	6.8	ns
		nOE to nBn	1.0	11.7	1.0	8.7	1.0	7.3	1.0	6.8	1.0	5.8	ns
t _{en}	enable time	n <mark>OE</mark> to nAn	0.5	5.9	0.5	5.9	0.5	5.9	0.5	5.9	0.5	5.9	ns
		nOE to nBn	0.5	13.8	0.5	10.4	0.5	8.1	0.5	5.7	0.5	5.0	ns
$V_{CC(A)} =$	3.0 V to 3.6 V												
t _{pd}	propagation	nAn to nBn	0.5	8.8	0.5	6.1	0.5	4.9	0.5	3.6	0.5	3.0	ns
	delay	nBn to nAn	0.5	5.4	0.5	4.1	0.5	3.7	0.5	3.2	0.5	3.0	ns
t _{dis}	disable time	nOE to nAn	0.5	5.5	0.5	5.5	0.5	5.5	0.5	5.5	0.5	5.5	ns
		nOE to nBn	1.0	11.4	1.0	8.5	1.0	7.2	1.0	5.8	0.5	5.5	ns
t _{en}	enable time	nOE to nAn	0.5	4.8	0.5	4.8	0.5	4.7	0.5	4.6	0.5	4.4	ns
		nOE to nBn	0.5	13.7	0.5	10.3	0.5	8.0	0.5	5.4	0.5	4.4	ns

Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C [1]

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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11. Waveforms



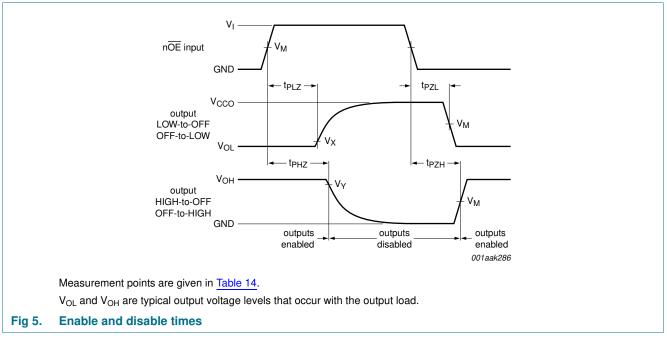


Table 14. Measurement points

Supply voltage	Input ^[1]	Output ^[2]		
$V_{CC(A)}, V_{CC(B)}$	V _M	V _M	V _X	V _Y
0.8 V to 1.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.1 V	$V_{OH} - 0.1 V$
1.65 V to 2.7 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.15 V	V _{OH} – 0.15 V
3.0 V to 3.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.3 V	V _{OH} – 0.3 V

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

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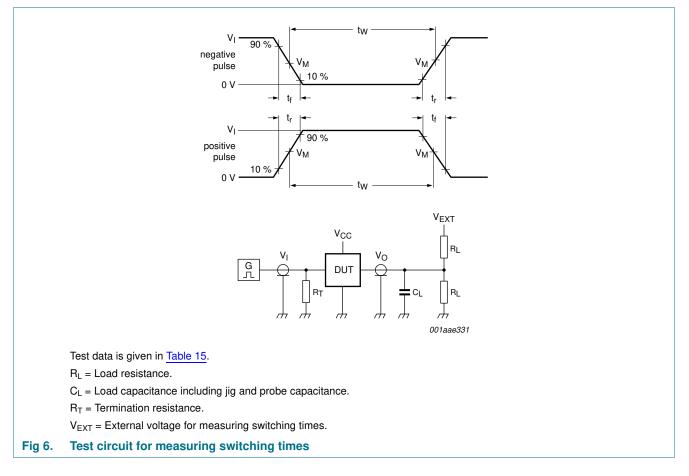


Table 15. Test data

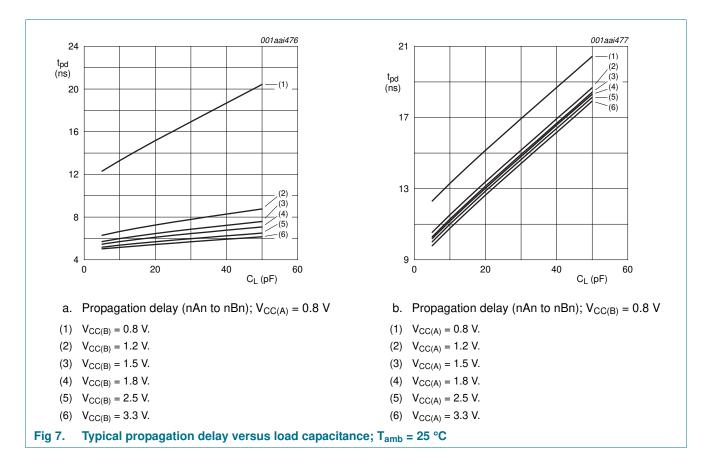
Supply voltage	Input		Load		V _{EXT}		
$V_{CC(A)}, V_{CC(B)}$	V _I [1]	Δt/ΔV[2]	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]
0.8 V to 1.6 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}
1.65 V to 2.7 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}
3.0 V to 3.6 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}

[1] V_{CCI} is the supply voltage associated with the data input port.

 $[2] \quad dV/dt \geq 1.0 \ V/ns$

[3] V_{CCO} is the supply voltage associated with the output port.

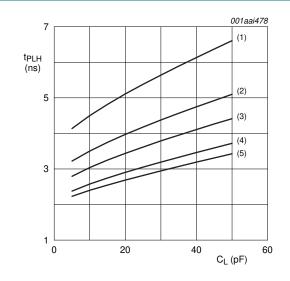
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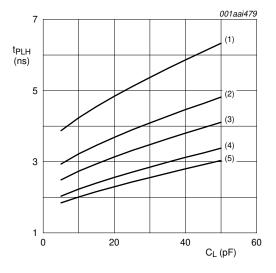
12. Typical propagation delay characteristics

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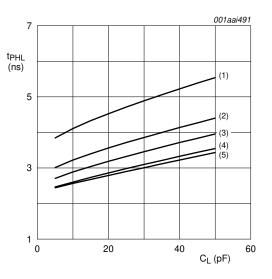


a. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)} = 1.2 \text{ V}$

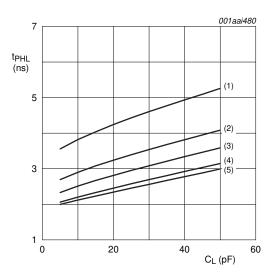


- c. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)} = 1.5 \text{ V}$
- (1) $V_{CC(B)} = 1.2$ V.
- (2) $V_{CC(B)} = 1.5$ V.
- (3) $V_{CC(B)} = 1.8$ V.
- (4) $V_{CC(B)} = 2.5$ V.
- (5) $V_{CC(B)} = 3.3$ V.

Fig 8. Typical propagation delay versus load capacitance; T_{amb} = 25 °C



b. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 1.2 \text{ V}$

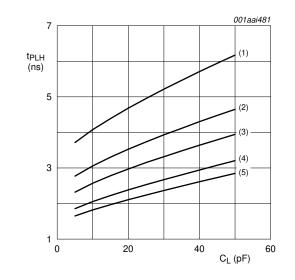


d. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 1.5 \text{ V}$

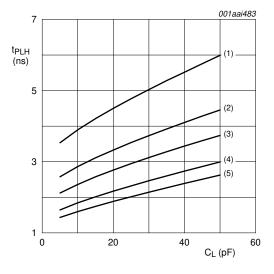
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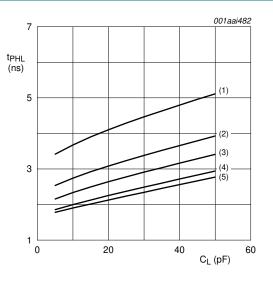


a. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)}$ = 1.8 V

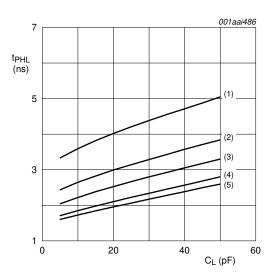


- c. LOW to HIGH propagation delay (nAn to nBn); $V_{CC(A)} = 2.5 \text{ V}$
- (1) $V_{CC(B)} = 1.2$ V.
- (2) $V_{CC(B)} = 1.5$ V.
- (3) $V_{CC(B)} = 1.8$ V.
- (4) $V_{CC(B)} = 2.5 V.$
- (5) $V_{CC(B)} = 3.3$ V.

Fig 9. Typical propagation delay versus load capacitance; T_{amb} = 25 °C



b. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 1.8 \text{ V}$



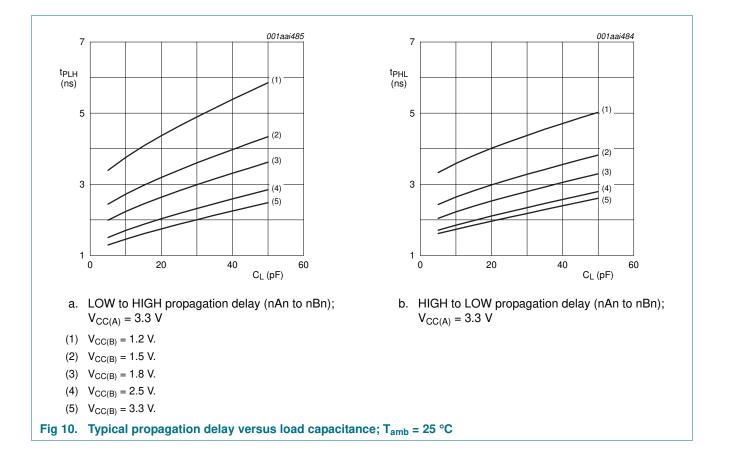
d. HIGH to LOW propagation delay (nAn to nBn); $V_{CC(A)} = 2.5 \text{ V}$

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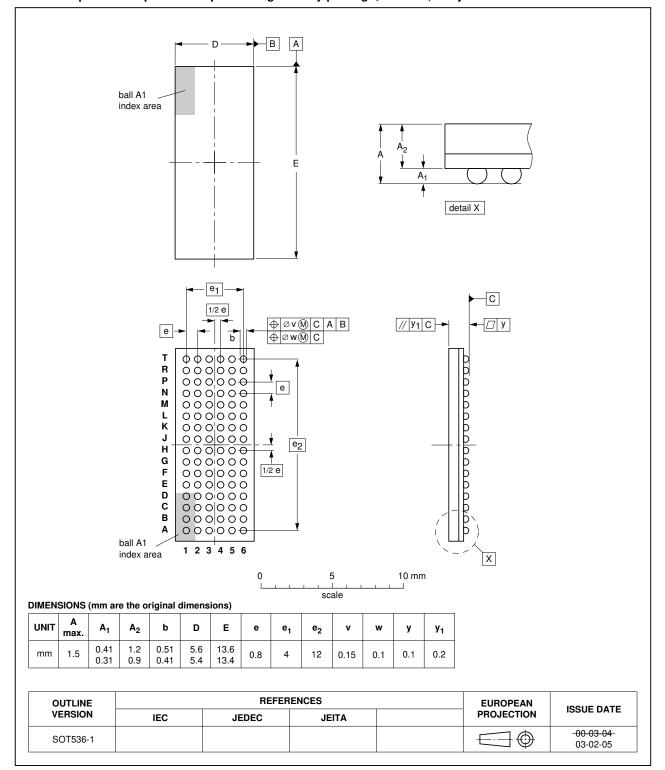
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13. Package outline



LFBGA96: plastic low profile fine-pitch ball grid array package; 96 balls; body 13.5 x 5.5 x 1.05 mm SOT536-1

Fig 11. Package outline SOT536-1 (LFBGA96)

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14. Abbreviations

Acronym CDM DUT	Description Charged Device Model
	Charged Device Model
DUT	-
	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 17. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVC32T245 v.1	20130116	Product data sheet	-	-

32-bit dual supply translating transceiver; 3-state

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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